# **Ultra-Low Voltage Buffer**

The NL17SV16XV5T2 is an ultra–high performance single Buffer fabricated in sub–micron silicon gate 0.35  $\mu m$  technology with excellent performance down to 0.9 V. This device is ideal for extremely high–speed and high–drive applications. Additionally, limitations of board space are no longer a constraint. The very small SOT–553 makes this device fit most tight designs and spaces.

The internal circuit is composed of three stages; including a buffered output which provides high noise immunity and stable output. The NL17SV16XV5T2 input structure provides protection when voltages up to 3.6 V are applied.

#### **Features**

- Extremely High Speed: 1.5 ns (Typ) at  $V_{CC} = 3.3 \text{ V}$
- Designed for 0.9 V to 3.6 V Operation
- Overvoltage Tolerance (OVT)\* Input Permits Logic Translation
- Balanced ±24 mA Output Drive @ 3.3 Volts
- Near Zero Static Supply Current
- Ultra-Tiny SOT-553 5 Pin Package Only 1.6 x 1.6 mm Footprint
- Ultra-Tiny SOT-553 5-Pin Package, only 1.6 x 1.6 x 0.6 mm
- These Devices are Pb-Free and are RoHS Compliant

## **Typical Applications**

- Cellular
- Digital Camera
- PDA
- Digital Video

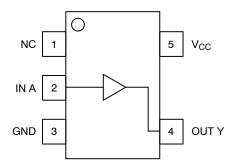


Figure 1. Pinout (Top View)

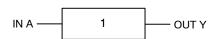


Figure 2. Logic Symbol



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SOT-553 CASE 463B



**MARKING** 

UN = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

#### **PIN ASSIGNMENT**

PIN#	FUNCTION
1	NC
2	IN A
3	GND
4	OUT Y
5	V <sub>CC</sub>

## **FUNCTION TABLE**

Input A	Output Y
L	L
Н	Н

#### **ORDERING INFORMATION**

Device	Package	Shipping†
NL17SV16XV5T2G	SOT-553 (Pb-Free)	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

<sup>\*</sup>Overvoltage Tolerance (OVT) enables input pins to function outside (higher) of their operating voltages, with no damage to the devices or to signal integrity.

## **MAXIMUM RATINGS**

Symbol	Rating	Value	Units
V <sub>CC</sub>	DC Supply Voltage	-0.5 to +4.6	V
VI	DC Input Voltage	-0.5 to +4.6	V
Vo	DC Output Voltage	-0.5 to V <sub>CC</sub> + 0.5	V
lıĸ	DC Input Diode Current V <sub>IN</sub> < 0 V	-50	mA
I <sub>OK</sub>	DC Output Diode Current VOUT < 0 V VOUT > VCC	-50 +50	mA
Io	DC Output Sink Current	±50	mA
I <sub>CC</sub>	DC Supply Current per Supply Pin	±50	mA
I <sub>GND</sub>	DC Ground Current per Ground Pin	±50	mA
T <sub>STG</sub>	Storage Temperature Range	-65 to +150	°C
TL	Lead Temperature, 1.0 mm from Case for 10 seconds	260	°C
TJ	Junction Temperature Under Bias	+150	°C
$\theta_{\sf JA}$	Thermal Resistance (Note 1)	250	°C/W
P <sub>D</sub>	Power Dissipation in Still Air at 85°C	250	mW
MSL	Moisture Sensitivity	Level 1	
F <sub>R</sub>	Flammability Rating Oxygen index: 28 to 34	UL 94 V-0 @ 0125 in	
V <sub>ESD</sub>	ESD Withstand Voltage Human Body Model (Note 2) Machine Model (Note 3)	2000 300	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow.
- 2. Tested to EIA/JESD22-A114-A.
- 3. Tested to EIA/JESD22-A115-A.

## **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Max	Units
V <sub>CC</sub>	Positive DC Supply Voltage	0.9	3.6	V
V <sub>IN</sub>	Digital Input Voltage	0	3.6	V
V <sub>out</sub>	Output Voltage	0	V <sub>CC</sub>	V
I <sub>OH</sub> /I <sub>OL</sub>	Output Current  V <sub>CC</sub> = 3.0 V to 3.6 V  V <sub>CC</sub> = 2.3 V to 2.7 V  V <sub>CC</sub> = 1.65 V to 1.95 V  V <sub>CC</sub> = 1.4 V to 1.6 V  V <sub>CC</sub> = 1.1 V to 1.3 V  V <sub>CC</sub> = 0.9 V		±24 ±18 ±6 ±4 ±2 ±0.1	mA
t <sub>A</sub>	Operating Temperature Range. All Package Types	-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Time $V_{CC} = 3.3V \pm 0.3 V$	0	10	nS/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

# DC CHARACTERISTICS – Digital Section (Voltages Referenced to GND)

_				T <sub>A</sub> =	25°C	$T_A = -40$	) to 85°C	
Symbol	Parameter	Condition	V <sub>cc</sub>	Min	Max	Min	Max	Units
V <sub>IH</sub>	High Level Input Voltage		$\begin{array}{c} 0.90 \\ 1.10 \leq V_{CC} \leq 1.30 \\ 1.40 \leq V_{CC} \leq 1.60 \\ 1.65 \leq V_{CC} \leq 1.95 \\ 2.30 \leq V_{CC} \leq 2.70 \\ 2.70 \leq V_{CC} \leq 3.60 \end{array}$	0.65 x V <sub>CC</sub> 0.65 x V <sub>CC</sub> 0.65 x V <sub>CC</sub> 0.65 x V <sub>CC</sub> 1.6 2.0		0.65 x V <sub>CC</sub> 0.65 x V <sub>CC</sub> 0.65 x V <sub>CC</sub> 0.65 x V <sub>CC</sub> 1.6 2.0		V
V <sub>IL</sub>	Low Level Input Voltage		$\begin{array}{c} 0.90 \\ 1.10 \leq V_{CC} \leq 1.30 \\ 1.40 \leq V_{CC} \leq 1.60 \\ 1.65 \leq V_{CC} \leq 1.95 \\ 2.30 \leq V_{CC} \leq 2.70 \\ 2.70 \leq V_{CC} \leq 3.60 \end{array}$		0.35 x V <sub>CC</sub> 0.35 x V <sub>CC</sub> 0.35 x V <sub>CC</sub> 0.35 x V <sub>CC</sub> 0.7 0.8		0.35 x V <sub>CC</sub> 0.35 x V <sub>CC</sub> 0.35 x V <sub>CC</sub> 0.35 x V <sub>CC</sub> 0.7 0.8	V
V <sub>OH</sub>	High Level Output Voltage	I <sub>OH</sub> = -100 μA	$\begin{array}{c} 0.90 \\ 1.10 \leq V_{CC} \leq 1.30 \\ 1.40 \leq V_{CC} \leq 1.60 \\ 1.65 \leq V_{CC} \leq 1.95 \\ 2.30 \leq V_{CC} \leq 2.70 \\ 2.70 \leq V_{CC} \leq 3.60 \end{array}$	V <sub>CC</sub> - 0.1 V <sub>CC</sub> - 0.1 V <sub>CC</sub> - 0.2 V <sub>CC</sub> - 0.2 V <sub>CC</sub> - 0.2 V <sub>CC</sub> - 0.2		V <sub>CC</sub> - 0.1 V <sub>CC</sub> - 0.1 V <sub>CC</sub> - 0.2 V <sub>CC</sub> - 0.2 V <sub>CC</sub> - 0.2 V <sub>CC</sub> - 0.2		V
		I <sub>OH</sub> = −2.0 mA	1.10 ≤ V <sub>CC</sub> ≤ 1.30	0.75 x V <sub>CC</sub>		0.75 x V <sub>CC</sub>		
		I <sub>OH</sub> = -4.0 mA	1.40 ≤ V <sub>CC</sub> ≤ 1.60	0.75 x V <sub>CC</sub>		0.75 x V <sub>CC</sub>		
		I <sub>OH</sub> = -6.0 mA	$1.65 \le V_{CC} \le 1.95 \\ 2.30 \le V_{CC} \le 2.70$	1.25 2.0		1.25 2.0		
		I <sub>OH</sub> = -12 mA	$2.30 \le V_{CC} \le 2.70$ $2.70 < V_{CC} \le 3.60$	1.8 2.2		1.8 2.2		
		I <sub>OH</sub> = -18 mA	$2.30 \le V_{CC} \le 2.70$ $2.70 < V_{CC} \le 3.60$	1.7 2.4		1.7 2.4		
		I <sub>OH</sub> = -24 mA	$2.70 \le V_{CC} \le 3.60$	2.2		2.2		
V <sub>OL</sub>	Low Level Output Voltage	I <sub>OL</sub> = 100 μA	$\begin{array}{c} 0.90 \\ 1.10 \leq V_{CC} \leq 1.30 \\ 1.40 \leq V_{CC} \leq 1.60 \\ 1.65 \leq V_{CC} \leq 1.95 \\ 2.30 \leq V_{CC} \leq 2.70 \\ 2.70 \leq V_{CC} \leq 3.60 \end{array}$		0.1 0.1 0.2 0.2 0.2 0.2		0.1 0.1 0.2 0.2 0.2 0.2	٧
		I <sub>OL</sub> = 2.0 mA	1.10 ≤ V <sub>CC</sub> ≤ 1.30		0.25 x V <sub>CC</sub>		0.25 x V <sub>CC</sub>	
		I <sub>OL</sub> = 4.0 mA	1.40 ≤ V <sub>CC</sub> ≤ 1.60		0.25 x V <sub>CC</sub>		0.25 x V <sub>CC</sub>	
		I <sub>OL</sub> = 6.0 mA	$1.65 \le V_{CC} \le 1.95$		0.3		0.3	
		I <sub>OL</sub> = 12 mA	$\begin{array}{c} 2.30 \leq V_{CC} \leq 2.70 \\ 2.70 < V_{CC} \leq 3.60 \end{array}$		0.4 0.4		0.4 0.4	
		I <sub>OL</sub> = 18 mA	$2.30 \le V_{CC} \le 2.70$ $2.70 < V_{CC} \le 3.60$		0.6 0.4		0.6 0.4	
		I <sub>OL</sub> = 24 mA	$2.70 \le V_{CC} \le 3.60$		0.55		0.55	
I <sub>IN</sub>	Input Leakage Current	0 = V <sub>I</sub> = 3.6 V	0.90 to 3.60		±0.1		±0.9	μА
I <sub>OFF</sub>	Power Off Leakage Current		0		1		5	μΑ
I <sub>CC</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND	0.90 to 3.60		0.9		5	μΑ

# **AC CHARACTERISTICS** (Input $t_r = t_f = 3.0 \text{ nS}$ )

		-40°	C		25°C	•	85	°C	
Symbol	Parameter	Condition	V <sub>CC</sub>	Min	Тур	Max	Min	Max	Units
T <sub>PHL,</sub>	Propagation Delay	$C_L$ = 15 pF, $R_L$ = 1.0 M $\Omega$	0.90		20				nS
T <sub>PLH</sub>		$C_L$ = 15 pF, $R_L$ = 2.0 k $\Omega$	$1.10 \le V_{CC} \le 1.30$ $1.40 \le V_{CC} \le 1.60$	2.0 1.0	6.0 3.2	13 6.1	1.0 1.0	16.9 7.0	nS
		$C_L$ = 30 pF, $R_L$ = 500 $\Omega$	$\begin{array}{c} 1.65 \leq V_{CC} \leq 1.95 \\ 2.30 \leq V_{CC} \leq 2.70 \\ 2.70 \leq V_{CC} \leq 3.60 \end{array}$	1.0 0.8 0.7	2.0 1.2 1.0	5.2 3.7 3.3	1.0 0.7 0.6	6.2 4.4 3.8	nS
C <sub>IN</sub>	Input Capacitance		0		2.0				pF
C <sub>OUT</sub>	Output Capacitance		0		4.5				pF
C <sub>PD</sub>	Power Dissipation Capacitance	V <sub>I</sub> = 0 V or V <sub>CC</sub> F = 10 MHz	0.90 to 3.60		20				pF

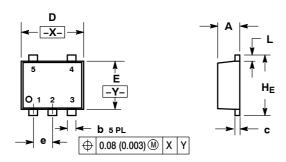
## DEVICE JUNCTION TEMPERATURE VERSUS TIME TO 0.1% BOND FAILURES

Junction Temperature °C	Time, Hours	Time, Years
80	1,032,200	117.8
90	419,300	47.9
100	178,700	20.4
110	79,600	9.4
120	37,000	4.2
130	17,800	2.0
140	8,900	1.0

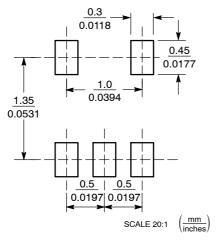


SOT-553, 5 LEAD CASE 463B **ISSUE C** 

**DATE 20 MAR 2013** 



#### **RECOMMENDED SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### NOTES:

- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETERS

  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
  THICKNESS: MINIMUM LEAD THICKNESS IS THE MINIMUM
  THICKNESS OF BASE MATERIAL.

	M	MILLIMETERS			INCHES	
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.50	0.55	0.60	0.020	0.022	0.024
b	0.17	0.22	0.27	0.007	0.009	0.011
С	0.08	0.13	0.18	0.003	0.005	0.007
D	1.55	1.60	1.65	0.061	0.063	0.065
E	1.15	1.20	1.25	0.045	0.047	0.049
е	0.50 BSC				0.020 BSC	
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	1.55	1.60	1.65	0.061	0.063	0.065

#### **GENERIC MARKING DIAGRAM\***



XX = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 1: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR	STYLE 2: PIN 1. CATHODE 2. COMMON ANODE 3. CATHODE 2 4. CATHODE 3 5. CATHODE 4	STYLE 3: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. CATHODE 1	STYLE 4: PIN 1. SOURCE 1 2. DRAIN 1/2 3. SOURCE 1 4. GATE 1 5. GATE 2	STYLE 5: PIN 1. ANODE 2. EMITTER 3. BASE 4. COLLECTOR 5. CATHODE
STYLE 6:	STYLE 7:	STYLE 8:	STYLE 9:	
PIN 1. EMITTER 2	PIN 1. BASE	PIN 1. CATHODE	PIN 1. ANODE	
2. BASE 2	2. EMITTER	2. COLLECTOR	2. CATHODE	
3. EMITTER 1	3. BASE	3. N/C	3. ANODE	
4. COLLECTOR 1	4. COLLECTOR	4. BASE	4. ANODE	
5. COLLECTOR 2/BASE 1	5. COLLECTOR	5. EMITTER	5. ANODE	

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PAGE 2 OF 2

ISSUE	REVISION	DATE
Α	ADDED STYLES 3-9. REQ. BY D. BARLOW	11 NOV 2003
В	ADDED NOMINAL VALUES AND UPDATED GENERIC MARKING DIAGRAM. REQ. BY HONG XIAO	27 MAY 2005
С	UPDATED DIMENSIONS D, E, AND HE. REQ. BY J. LETTERMAN.	20 MAR 2013

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